

MOSFET

600V CoolMOS™ SJ S7A Power Device

CoolMOSTM S7A reduce $R_{DS(on)}$ values for an HV SJ MOSFET, with a distinctive increase in energy efficiency. CoolMOSTM S7A is optimized for "static switching" and high current applications. The embedded temperature sensor increases junction temperature sensing accuracy and robustness while keeping an easy and seamless implementation.

Features

- CoolMOS™ S7A technology enables lowest R_{DS(on)} and high pulse current capability in the smallest footprint
- Optimized price performance in low-frequency switching applications
- Seamless diagnostics at lowest system cost
- Temperature sense feature for protection and optimized thermal device utilization

Benefits

- Minimized conduction losses (reduced heat sink size)
- · Increased system performance
- Lower BOM or/and TCO over a prolonged lifetime
- Reduction of external sensing elements

Compared to electromechanical devices:

- · Faster switching times; More reliability and longer system lifetime
- · Shock & Vibration resistance; No contact arcing or bouncing

Potential applications

- · Solid state relays and circuit breakers
- · Line rectification in high power/performance applications

Product validation

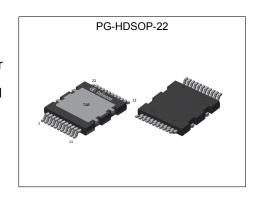
Qualified according to AEC Q101

Please note: The source and sense source pins are not exchangeable. Their exchange might lead to malfunction. For paralleling 4pin MOSFET devices the placement of the gate resistor is generally recommended to be on the Driver Source instead of the Gate. For production part approval process (PPAP) release we propose to share application related information during an early design phase to avoid delays in PPAP release. Please contact Infineon sales office.



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Parameter	Value	Unit					
R _{DS(on),max}	10	mΩ					
$Q_{g,typ}$	318	nC					
V _{SD}	0.82	V					
Pulsed I _{SD} , I _{DS}	796	A					
ESD class (HBM)	2	JEDEC AEC Q101					

Type / Ordering Code	Package	Marking	Related Links
IPDQ60T010S7A	PG-HDSOP-22	60T010S7	see Appendix A



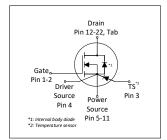












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1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Maximum MOSFET ratings Table 2

Devementar	Cumbal	Values			l lmi4		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain current rating ¹⁾	I _D	-	-	174 50	А	T _C =25°C T _C =140°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	796	Α	T _C =25°C	
Avalanche energy, single pulse	E AS	-	-	612	mJ	I_D =6.3A; V_{DD} =50V; see table 12	
Avalanche current, single pulse	I _{AS}	-	-	6.3	Α	-	
MOSFET dv/dt ruggedness ³⁾	dv/dt	-	-	20	V/ns	V _{DS} = 0V to 300V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	694	W	<i>T</i> _C =25°C	
Storage temperature	T _{stg}	-55	-	150	°C	-	
Operating junction temperature ¹⁾	T _j	-40	-	150	°C	-	
Extended operating junction temperature	T _j	150	-	175	°C	≤50 h in the application lifetime	
Mounting torque	-	-	-	n.a.	Ncm	-	
Diode forward current rating	I _S	-	-	50	A	T _C =140°C Current is limited by T _{j max} = 150°C; Lower case temp does increase current capability	
Diode pulse current ²⁾	I _{S,pulse}	-	-	796	Α	T _C =25°C	
Reverse diode dv/dt ⁴⁾	dv/dt	-	-	5	V/ns	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ <=50A, $T_{\rm j}$ =25°C see table 10	
Maximum diode commutation speed	di _f /dt	-	-	800	A/μs	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ <=50A, $T_{\rm j}$ =25°C see table 10	
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	-	

 $^{^{1)}}$ Please consider the App Note: 600 V CoolMOS $^{\text{TM}}$ S7 with Temperature Sense for high delta T $_{\text{J}}$ usage $^{2)}$ Pulse width t_{p} limited by $T_{\text{j,max}}$ $^{3)}$ The dv/dt has to be limited by appropriate gate resistor $^{4)}$ Identical low side and high side switch



2 Thermal characteristics

Table 3 Thermal characteristics

Davisantan	Ol	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.18	°C/W	-
Thermal resistance, junction - ambient	R _{thJA}	-	-	62	°C/W	device on PCB, minimal footprint
Thermal resistance, junction - ambient for SMD version		-	45	55	°C/W	Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thickness) copper area. Tap exposed to air. PCB is vertical without air stream cooling.
Soldering temperature, reflow soldering allowed	T _{sold}	-	-	260	°C	reflow MSL1



Electrical characteristics

at T_i=25°C, unless otherwise specified

Table 4 Static characteristics

The CoolMOS[™] mentioned in this datasheet shall not be operated in linear mode.

For any questions in this regard, please contact Infineon sales office.

For applications with applied blocking voltage >400V, it is required that the customer

evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the necessary technical support by Infineon

Parameter.	Cumbal	Values			11	Nata / Table Oam difficu	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V _{GS} =0V, I _D =1mA	
Gate threshold voltage	$V_{(GS)th}$	3.5	4.0	4.5	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=3.06{\rm mA}$	
Zero gate voltage drain current	I _{DSS}	-	- 80	8 -	μΑ	V _{DS} =600V, V _{GS} =0V, T _j =25°C V _{DS} =600V, V _{GS} =0V, T _j =150°C	
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V	
Drain-source on-state resistance	R _{DS(on)}	-	0.009 0.022	0.010	Ω	V _{GS} =12V, I _D =50A, T _j =25°C V _{GS} =12V, I _D =50A, T _j =150°C	
Gate resistance	R _G	-	0.45	-	Ω	f=1MHz, open drain	

Table 5 Dynamic characteristicsExternal parasitic elements (PCB layout) influence switching behavior significantly.

Stray inductances and coupling capacitances must be minimized.

For layout recommendations please use provided application notes or contact Infineon sales office.

Davamatar	Complete	Values			11	Nata / Tank Oass differen	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	Ciss	-	11986	-	pF	V _{GS} =0V, V _{DS} =300V, f=250kHz	
Output capacitance	Coss	-	188	-	pF	V _{GS} =0V, V _{DS} =300V, f=250kHz	
Effective output capacitance, energy related ¹⁾	C _{o(er)}	-	643	-	pF	V _{GS} =0V, V _{DS} =0 to 300V	
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	5714	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0 to 300V	
Output charge	Qoss	-	1714	-	nC	V _{GS} =0V, V _{DS} =0 to 300V	
Turn-on delay time	$t_{\sf d(on)}$	-	32	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =50A, $R_{\rm G}$ =3 Ω ; see table 11	
Rise time	t _r	-	12	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =50A, $R_{\rm G}$ =3 Ω ; see table 11	
Turn-off delay time	$t_{\sf d(off)}$	-	170	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =50A, $R_{\rm G}$ =3 Ω ; see table 11	
Fall time	t _f	-	9	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =50A, $R_{\rm G}$ =3 Ω ; see table 11	

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 300V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 300V



 Table 6
 Gate charge characteristics

Parameter	Symbol		Values			Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	69	-	nC	V_{DD} =300V, I_{D} =50A, V_{GS} =0 to 12V
Gate to drain charge	$Q_{ m gd}$	-	105	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =50A, $V_{\rm GS}$ =0 to 12V
Gate charge total	Qg	-	318	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =50A, $V_{\rm GS}$ =0 to 12V
Gate plateau voltage	$V_{ m plateau}$	-	5.7	-	V	V_{DD} =300V, I_{D} =50A, V_{GS} =0 to 12V

Table 7 Reverse diode characteristics

Paramatan	Symbol	Values			11!4	Nata / Tant Candition
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	V _{SD}	-	0.82	-	V	V _{GS} =0V, I _F =50A, T _j =25°C
Reverse recovery time	t _{rr}	-	600	-	ns	V_R =300V, I_F =50A, di_F/dt =100A/ μ s; see table 10
Reverse recovery charge	Qrr	-	17	-	μC	V_R =300V, I_F =50A, di_F/dt =100A/ μ s; see table 10
Peak reverse recovery current	I _{rrm}	-	55	-	А	$V_{\rm R}$ =300V, $I_{\rm F}$ =50A, d $i_{\rm F}$ /d t =100A/ μ s; see table 10



4 Temperature Sensor parameters at T_j =25°C, unless otherwise specified

Maximum ratings Table 8

D	Cumb al		Values			Note / Tool Oo wild on
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Repetitive Peak Reverse Voltage	V_{RRM}	-	-	15	V	<i>I</i> _R = 100 μA
Sensor forward current	I _F	-	-	5	mA	-
Repetitive peak forward current	I _{F_pulse}	_	-	25	mA	t _{pulse} = 1 ms, T _{period} = 10 ms
Non-repetitive peak forward current	I _{FSM}		-	1.5 0.2 0.1	A	T_C = 25°C, t_{pulse} = 1 μs T_C = 25°C, t_{pulse} = 1 ms T_C = 25°C, t_{pulse} = 1 s
Junction Temperature	T _j	_	-	185	°C	t < 50h, Sensor only

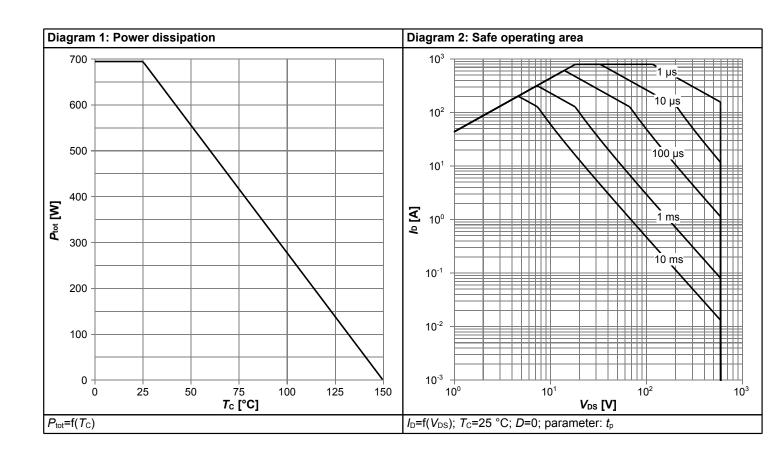
Electrical characteristics Table 9

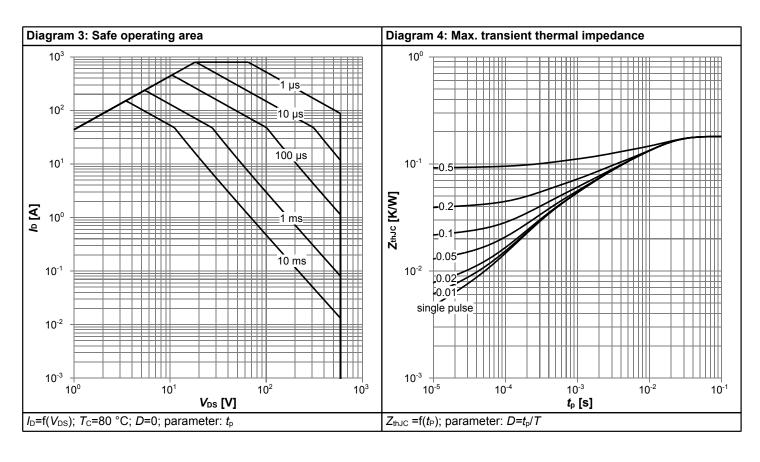
Parameter	Symbol	Values			Unit	Note / Test Condition	
raiailletei	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition	
Sensor forward voltage ¹⁾	V _{F_25}	1.5601 - - 2.0665	1.6019 1.8103 1.9806 2.0966	-	V	$T_{j} = 25^{\circ}\text{C}, I_{F} = 10 \ \mu\text{A}$ $T_{j} = 25^{\circ}\text{C}, I_{F} = 50 \ \mu\text{A}$ $T_{j} = 25^{\circ}\text{C}, I_{F} = 200 \ \mu\text{A}$ $T_{j} = 25^{\circ}\text{C}, I_{F} = 500 \ \mu\text{A}$	
Sensor forward voltage temperature coefficient	TC	- - -	5.9644 5.5880 5.2287 5.0135	-	mV/K	$\begin{array}{l} 25^{\circ}C \leq T_{j} \leq 175^{\circ}C, \ I_{F} = 10 \ \mu A \\ 25^{\circ}C \leq T_{j} \leq 175^{\circ}C, \ I_{F} = 50 \ \mu A \\ 25^{\circ}C \leq T_{j} \leq 175^{\circ}C, \ I_{F} = 200 \ \mu A \\ 25^{\circ}C \leq T_{j} \leq 175^{\circ}C, \ I_{F} = 500 \ \mu A \\ \end{array}$	
Sensor forward voltage	V _{F_175}	-	0.7072 0.9721 1.1963 1.3445	-	V	$T_{j} = 175^{\circ}\text{C}, I_{F} = 10 \mu\text{A}$ $T_{j} = 175^{\circ}\text{C}, I_{F} = 50 \mu\text{A}$ $T_{j} = 175^{\circ}\text{C}, I_{F} = 200 \mu\text{A}$ $T_{j} = 175^{\circ}\text{C}, I_{F} = 500 \mu\text{A}$	
Reverse leakage current	I _R	-	-	1 20	μA	$V_R = 10V, T_j = 25^{\circ}C$ $V_R = 10V, T_j = 175^{\circ}C$	
Sensor G Capacitance	C _{GTS}	-	4.2	-	pF	f = 1 MHz, I _F = 50 μA	
Sensor Capacitance	C _{STS}	-	4.8	-	pF	f = 1 MHz, I _F = 50 μA	
Anode-Drain Capacitance	C _{DTS}	-	0.5	-	pF	f = 1 MHz, V _{DS} = 0 V	

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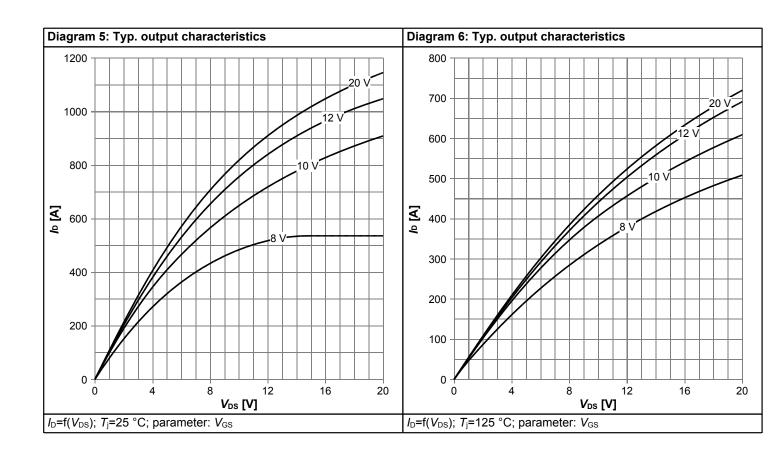


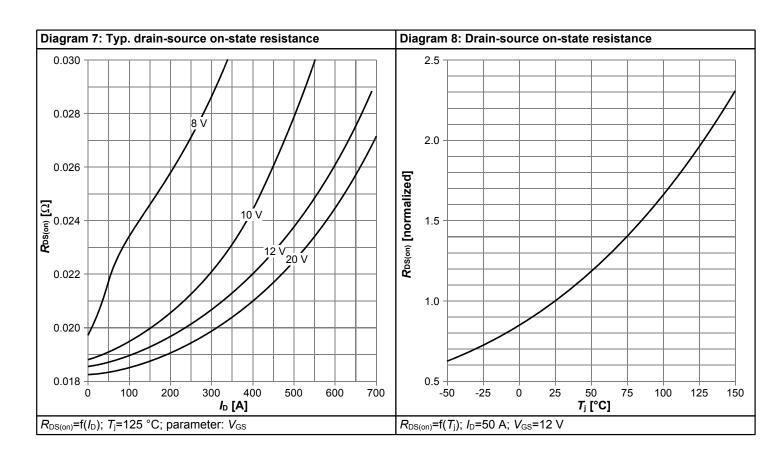
5 Electrical characteristics diagrams



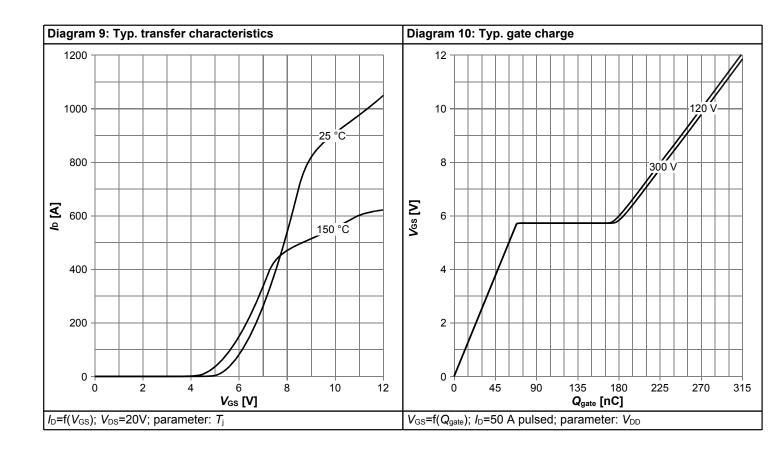


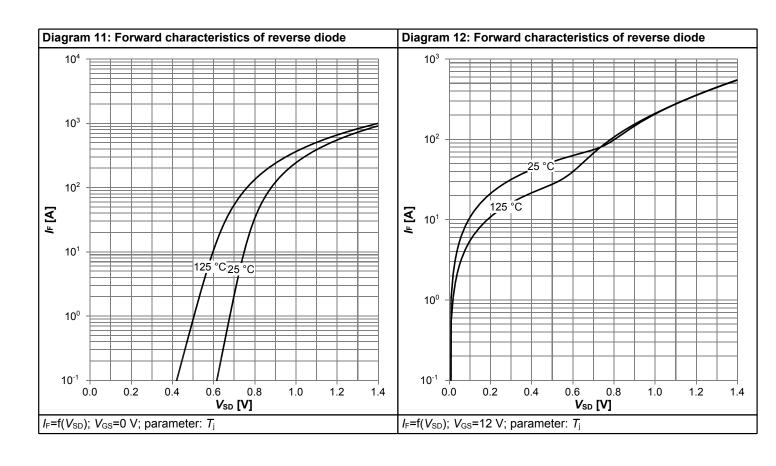




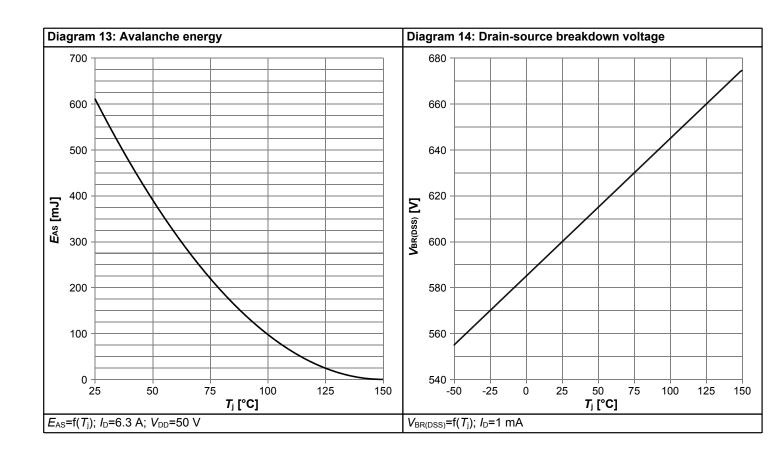


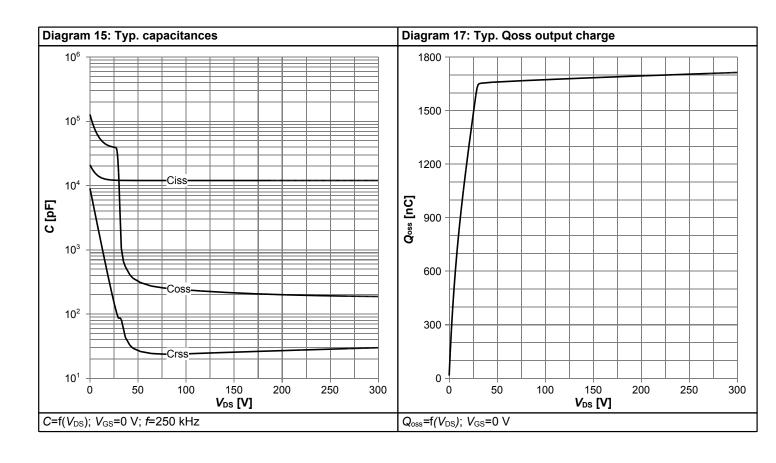




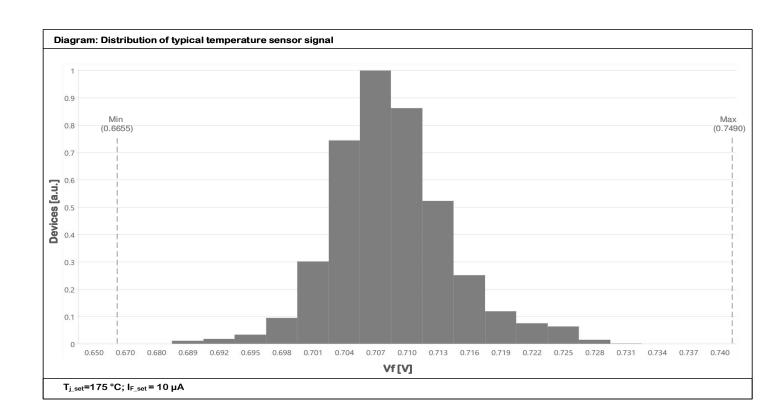














6 Test Circuits

Table 10 Diode characteristics

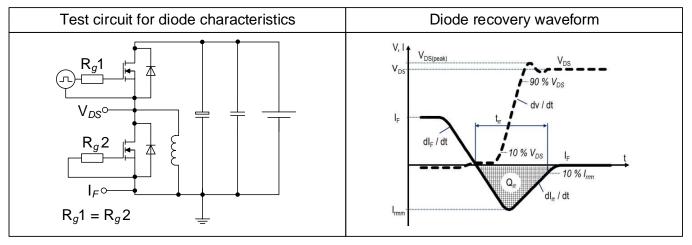


Table 11 Switching times (ss)

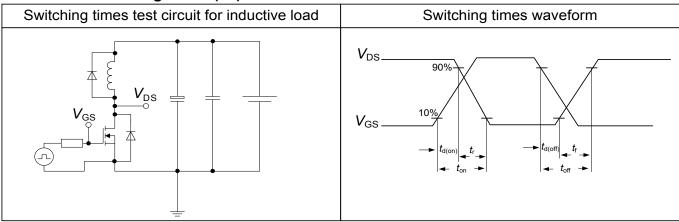
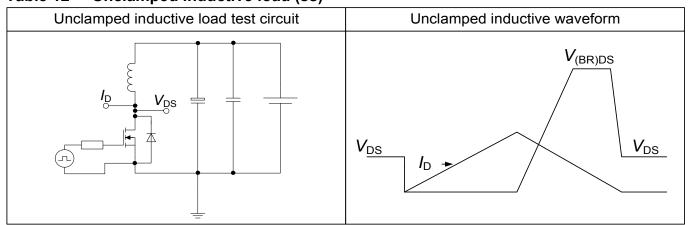


Table 12 Unclamped inductive load (ss)





7 Package Outlines

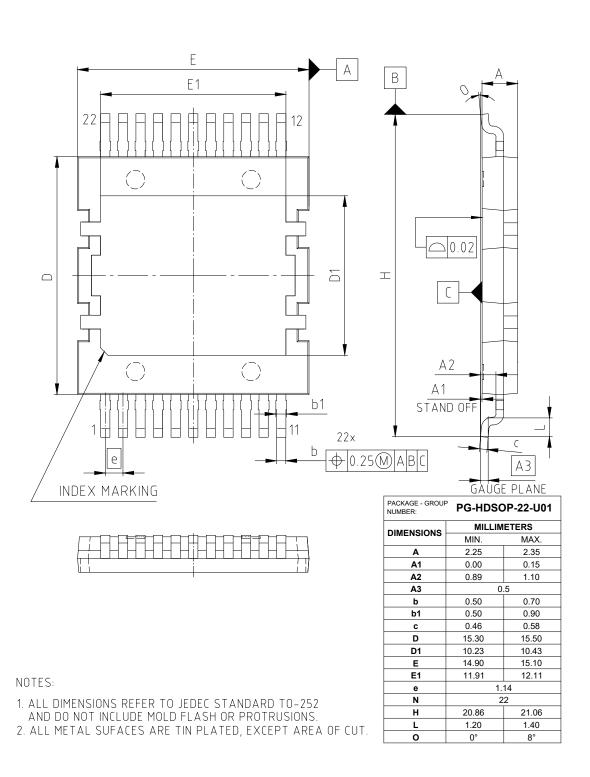


Figure 1 Outline PG-HDSOP-22, dimensions in mm

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8 Appendix A

Table 13 Related Links

• IFX CoolMOS™ S7TA Webpage: www.infineon.com

• IFX CoolMOS™ S7TA application note: www.infineon.com

• IFX CoolMOS™ S7TA simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

600V CoolMOS™ SJ S7A Power Device



Revision History

IPDQ60T010S7A

Revision: 2024-03-18, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2024-03-18	Release of final version

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